

Printed Electronics Forum- powered by OE-A and LOPEC, Nov. 10 and 12



Flexible and Printed Electronics: Applications & Technologies

Date: Tuesday, November 10, 2026

Time: 13.00 – 16.00 h

Place: PCB and EMS Marketplace, Hall A1.363, Messe Munich

Moderation Dr. Klaus Hecker, Managing Director, OE-A

- 13:00 h Introduction to Flexible and Printed Electronics
Dr. Klaus Hecker, Managing Director, OE-A (DE)
- 13:20 h Next-generation roll-to-roll printed and hybrid electronics technologies
towards smarter, flexible, lighter weight, and sustainable functional
solutions
Prof. Jukka Hast, Research Manager, VTT (FI)
- 13:40 h When should you NOT use printed electronics?
Pawel Czabak, CEO, LC Elektronik (PL)
- 14:00 h Software Defined Functions: New Avenues for Printed Electronics?
Dr. Alain Schumacher, CTO, IEE (LU)
- 14:20 h When Every Micron Counts: Printing, Repairing and Tuning Circuits at the
1 μ m Scale
Dr. Witold Nawrot, Strategic Partnership Lead, XTPL (PL)
- 14:40 h Printed electronics: a responsible alternative for PCBs
Corne Rentrop, CTO, TracXon, (NL)
- 15:00 h Compostable electronics as a reality
Dr. Ofer Shochet, CEO and Founder, Copprint (IL)

OE-A · VDMA e.V.

Chairman: Dr. Alain Schumacher
Managing Director:
Dr. Klaus Hecker

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- 15:20 h A Circular Ink–Machine Pairing: Fully Recyclable Functional Ink Meets High-Speed Industrial Screen Printing
Leonardo Giacomini, Product Manager for Printed Electronics, VFP Ink Technologies (FR)
Matthias Nessler, International Sales Manager, SPS TechnoScreen (DE)
- 15:40 h Towards sustainable electronics – recent developments on paper-based electronics
Dr. Daniela Collin, CeSMA – Center Smart Materials & Adaptive Systems, Teamleader New Materials, Fraunhofer ISC (DE)
- 16:00 h Summary & Adjourn
Dr. Klaus Hecker, Managing Director, OE-A (DE)

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Flexible and Printed Electronics for Automotive Applications

Date: Thursday, November 12, 2026

Time: 13.00 – 15.00 h

Place: Automotive Forum, Hall B4.445, Messe Munich

- 13:00 h Introduction to Flexible and Printed Electronics
Raswanth Sendhil Sasikala, Project Manager, OE-A (DE)
- 13:20 h Multi-Color Dynamic Surfaces Using E Ink technology
Pete Valianatos, President & Managing Director, E Ink Technology (NL)
- 13:40 h Textronics: Smart Textiles for All - Enabled by Conductive Transfer Technology
Declan Flannery, Vice President, INTERLINK Electronics (US)
- 14:00 h 2 mm to Integrate: Automated Narrow-Tape Mounting and EMI Shielding for
Frameless Automotive Displays and Smart Surfaces
Dr. Jonathan Martens, Regional Market Segment Manager, tesa SE (DE)
- 14:20 h Automotive flex production is back in Europe, at volume, now
Dr. Roman Armgarth, CTO, DP Patterning (SE)
- 14:40 h Real-Time Pressure Monitoring for Enhanced Battery Intelligence: Mechanical
Indicators of SoC and SoH in Prismatic LFP Cells
Dr. Jean-Charles Flores, Project Manager, FLEXOO (DE)
- 15:00 h Summary & Adjourn
Raswanth Sendhil Sasikala, Project Manager, OE-A (DE)